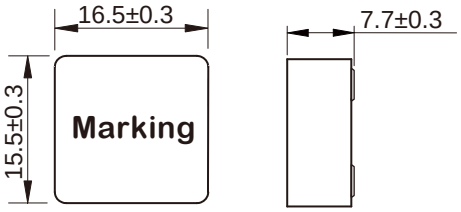
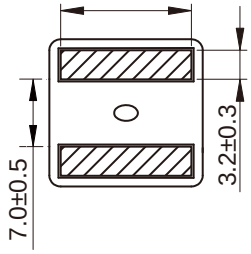
Dimensions: [mm]

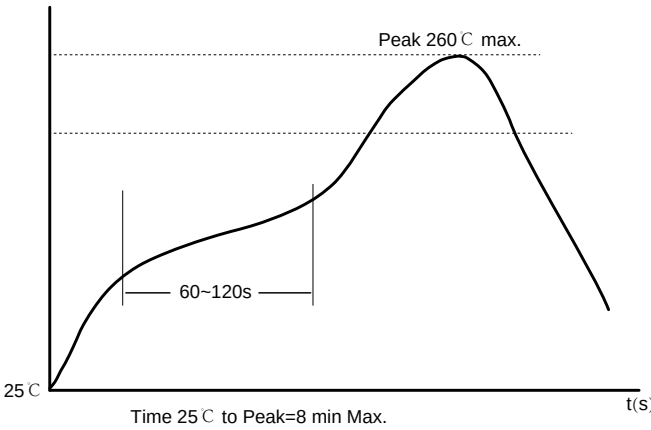


Land Pattern: [mm]



Electrical Properties:

Soldering Reflow:



Preheat condition: 150 ~200℃/ 60~120 sec.

Allowed time above 217℃: 60~90 sec.

Max temperature: 260℃.

Max time at max temperature: 10 sec.

Allowed Reflow time: 2x max.

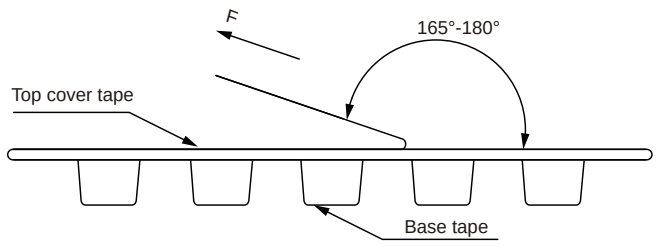
t(s)852 0479 85207 8/TT1 ec.12.538 -1.806 T00095/TT1 1 Tf(85137934)Tj(

Packaging Information:

Tape Dimension:

Series	A0 (mm)	B0 (mm)	D (mm)	P0 (mm)	P1 (mm)	W (mm)	K0 (mm)	E (mm)	T (mm)
MDTE1580	17.0±0.1	16.0±0.1	1.5±0.1	4.0±0.1	24.0±0.1	32.0±0.3	8.5±0.1	1.75±0.1	0.5±0.05

Peel force of top cover tape:



The peel force of top cover tape shall be between 0.1 to 1.3 N

Reel Dimension：[mm]

Packaging Quantity: